

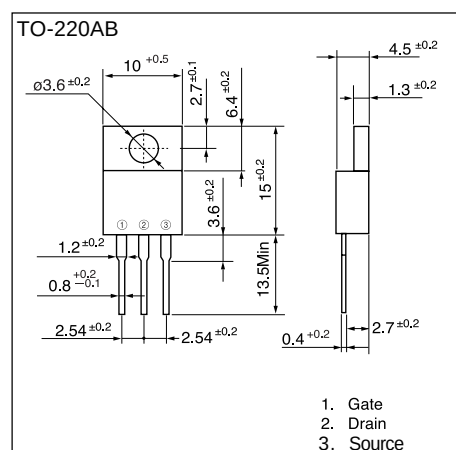
# N-CHANNEL SILICON POWER MOS-FET

## ■ Features

- High speed switching
- Low on-resistance
- No secondary breakdown
- Low driving power
- Avalanche-proof

## ■ Applications

Switching regulators  
UPS (Uninterruptible Power Supply)  
DC-DC converters



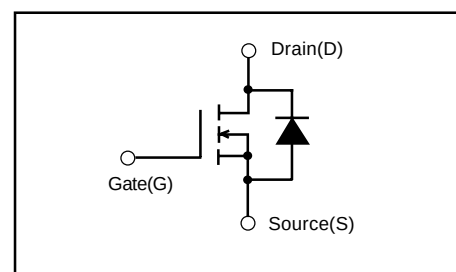
### ■ Maximum ratings and characteristicAbsolute maximum ratings

● (Tc=25°C unless otherwise specified)

| Item                                    | Symbol                | Rating              | Unit                       |
|-----------------------------------------|-----------------------|---------------------|----------------------------|
| Drain-source voltage                    | $V_{DS}$              | 60                  | V                          |
| Continuous drain current                | $I_D$                 | $\pm 50$            | A                          |
| Pulsed drain current                    | $I_{D(puls)}$         | $\pm 200$           | A                          |
| Gate-source voltage                     | $V_{GS}$              | $\pm 30$            | V                          |
| Maximum Avalanche Energy                | $E_{AV*1}$            | 867                 | mJ                         |
| Max. power dissipation                  | $P_D$                 | 80                  | W                          |
| Operating and storage temperature range | $T_{ch}$<br>$T_{stg}$ | +150<br>-55 to +150 | $^{\circ}C$<br>$^{\circ}C$ |

\*1 L=0.463mH, Vcc=24V

### ■ Equivalent circuit schematic



● **Electrical characteristics (T<sub>c</sub> =25°C unless otherwise specified)**

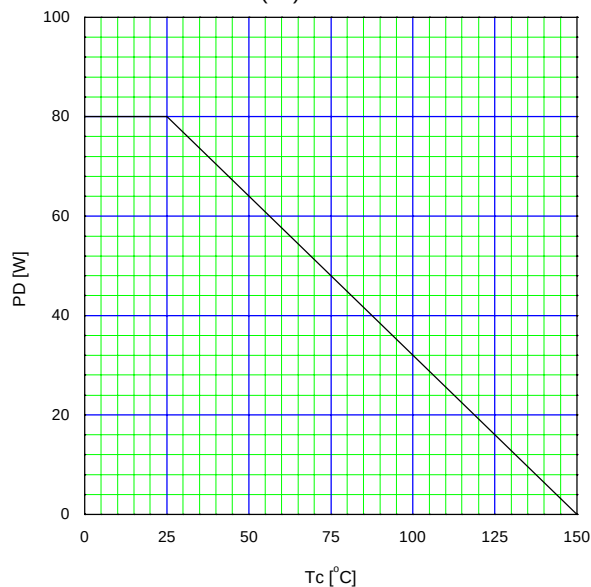
| Item                             | Symbol   | Test Conditions         |           | Min. | Typ. | Max. | Units |
|----------------------------------|----------|-------------------------|-----------|------|------|------|-------|
| Drain-source breakdown voltage   | V(BR)DSS | Id=1mA VGS=0V           |           | 60   |      |      | V     |
| Gate threshold voltage           | VGS(th)  | Id=1mA                  | VDS=VGS   | 2.5  | 3.0  | 3.5  | V     |
| Zero gate voltage drain current  | IDSS     | VDS=60V                 | Tch=25°C  |      | 10   | 500  | μA    |
|                                  |          | VGS=0V                  | Tch=125°C |      | 0.2  | 1.0  | mA    |
| Gate-source leakage current      | IGSS     | VGS=±30V VDS=0V         |           |      | 10   | 100  | nA    |
| Drain-source on-state resistance | RDS(on)  | Id=40A VGS=10V          |           |      | 9.5  | 12   | mΩ    |
| Forward transconductance         | gfs      | Id=40A VDS=25V          |           | 20   | 40   |      | S     |
| Input capacitance                | Ciss     | VDS=25V                 |           |      | 3100 | 4650 | pF    |
| Output capacitance               | Coss     | VGS=0V                  |           |      | 1300 | 1950 |       |
| Reverse transfer capacitance     | Crss     | f=1MHz                  |           |      | 350  | 530  |       |
| Turn-on time ton                 | td(on)   | VCC=30V ID=80A          |           |      | 20   | 30   | ns    |
|                                  | tr       | VGS=10V                 |           |      | 85   | 120  |       |
| Turn-off time toff               | td(off)  | RGS=10 Ω                |           |      | 88   | 130  |       |
|                                  | tr       |                         |           |      | 65   | 120  |       |
| Avalanche capability             | IAV      | L=100μH Tch=25°C        |           | 50   |      |      | A     |
| Diode forward on-voltage         | VSD      | IF=50A VGS=0V Tch=25°C  |           |      | 1.0  | 1.5  | V     |
| Reverse recovery time            | trr      | IF=50A VGS=0V           |           |      | 70   |      | ns    |
| Reverse recovery charge          | Qrr      | -di/dt=100A/μs Tch=25°C |           |      | 0.13 |      | μC    |

## ● Thermal characteristics

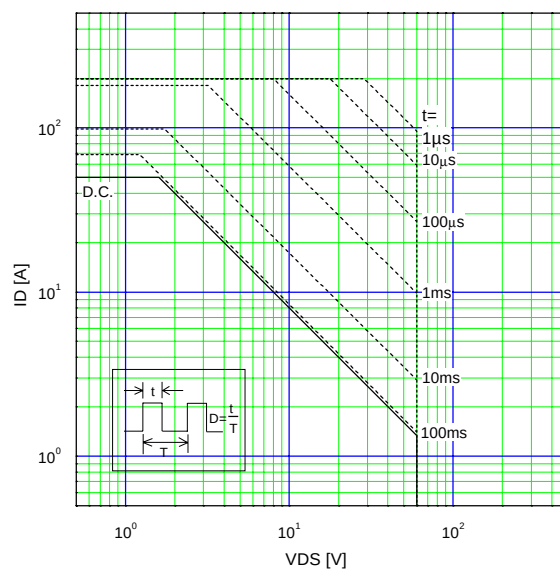
| Item               | Symbol                | Test Conditions    | Min. | Typ. | Max. | Units |
|--------------------|-----------------------|--------------------|------|------|------|-------|
| Thermal resistance | R <sub>th(ch-c)</sub> | channel to case    |      |      | 1.56 | °C/W  |
|                    | R <sub>th(ch-a)</sub> | channel to ambient |      |      | 75.0 | °C/W  |

## Characteristics

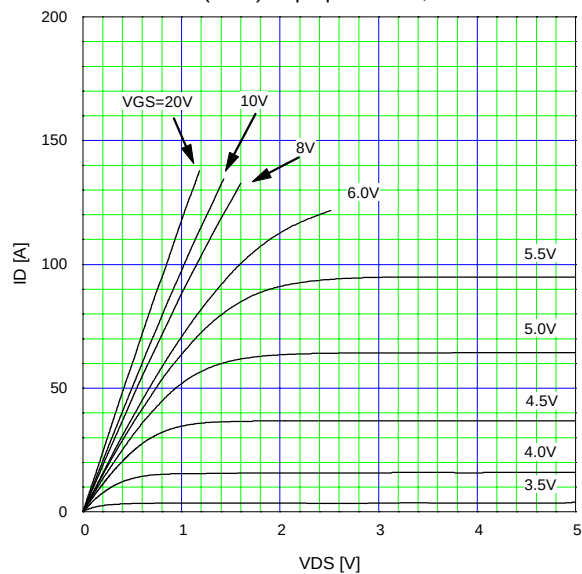
Power Dissipation  
 $PD=f(T_c)$



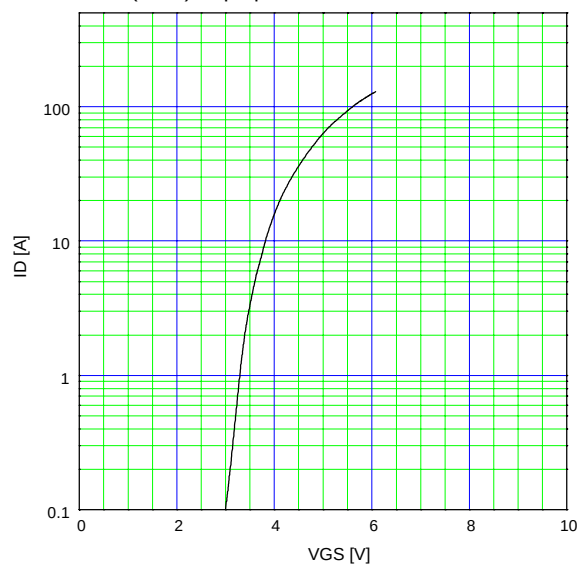
Safe operating area  
 $ID=f(V_{DS}):D=0.01, T_c=25^{\circ}C$



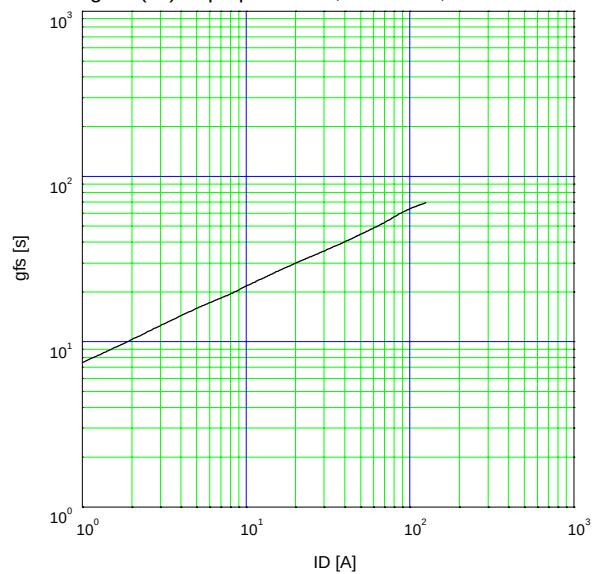
Typical output characteristics  
 $ID=f(V_{DS}):80\mu s$  pulse test,  $T_c=25^{\circ}C$



Typical transfer characteristics  
 $ID=f(V_{GS}):80\mu s$  pulse test,  $V_{DS}=25V, T_{ch}=25^{\circ}C$



Typical forward transconductance  
 $g_{fs}=f(ID):80\mu s$  pulse test,  $V_{DS}=25V, T_{ch}=25^{\circ}C$



Typical Drain-Source on-State Resistance  
 $R_{DS(on)}=f(ID):80\mu s$  pulse test,  $T_{ch}=25^{\circ}C$

